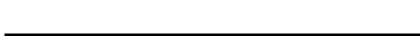
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April 1st, 2010 Renesas Electronics Corporation

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DATA SHEET



MOS FIELD EFFECT TRANSISTOR NP50P06SDG

SWITCHING P-CHANNEL POWER MOSFET

DESCRIPTION

The NP50P06SDG is P-channel MOS Field Effect Transistor designed for high current switching applications.

ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
NP50P06SDG-E1-AY Note		Tape 2500 p/reel	TO 050 (MD 0714)	
NP50P06SDG-E2-AY Note	DP06SDG-E2-AY Note Pure Sn (Tin)		TO-252 (MP-3ZK)	

Note Pb-free (This product does not contain Pb in external electrode.)

FEATURES

• Super low on-state resistance

 $R_{DS(on)1} = 16.5 \text{ m}\Omega \text{ MAX}. \text{ (Vgs} = -10 \text{ V, I}_D = -25 \text{ A})$

 $R_{DS(on)2} = 23.0 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = -4.5 \text{ V, Ip} = -25 \text{ A})$

• Low input capacitance

Ciss = 5000 pF TYP.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	(/		
Drain to Source Voltage (V _{GS} = 0 V)	VDSS	-60	V
Gate to Source Voltage (V _{DS} = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	I _{D(DC)}	∓50	Α
Drain Current (pulse) Note1	D(pulse)	∓150	Α
Total Power Dissipation (Tc = 25°C)	P _{T1}	84	W
Total Power Dissipation (T _A = 25°C)	P _{T2}	1.2	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note2	las	32	Α
Single Avalanche Energy Note2	Eas	102	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = $-20 \rightarrow 0$ V

THERMAL RESISTANCE

<R>

Channel to Case Thermal Resistance	Rth(ch-C)	1.78	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	125	°C/W

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NEC 10.2524

(TO-252)

Document No. D19073EJ2V0DS00 (2nd edition) Date Published March 2008 NS Printed in Japan



ELECTRICAL CHARACTERISTICS (TA = 25°C)

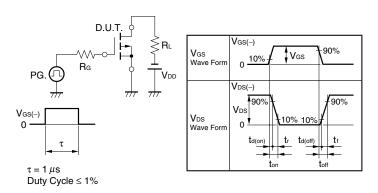
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ioss	V _{DS} = -60 V, V _{GS} = 0 V			-10	μΑ
Gate Leakage Current	Igss	V _{GS} = ∓20 V, V _{DS} = 0 V			∓100	nA
Gate to Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.0	-1.6	-2.5	V
Forward Transfer Admittance Note	y fs	V _{DS} = -10 V, I _D = -25 A	15	33		S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = -10 V, I _D = -25 A		13.2	16.5	mΩ
	RDS(on)2	V _{GS} = -4.5 V, I _D = -25 A		14.9	23.0	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V,		5000		pF
Output Capacitance	Coss	V _{GS} = 0 V,		600		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		300		pF
Turn-on Delay Time	t _{d(on)}	$V_{DD} = -30 \text{ V}, I_{D} = -25 \text{ A},$		13		ns
Rise Time	t r	V _{GS} = -10 V,		13		ns
Turn-off Delay Time	t _{d(off)}	R _G = 0 Ω		405		ns
Fall Time	tf			180		ns
Total Gate Charge	Q _G	V _{DD} = -48 V,		100		nC
Gate to Source Charge	Q _G s	V _{GS} = -10 V,		11		nC
Gate to Drain Charge	Q _{GD}	I _D = -50 A		30		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = -50 A, V _{GS} = 0 V		0.97	1.5	V
Reverse Recovery Time	trr	IF = -50 A, VGS = 0 V,		50		ns
Reverse Recovery Charge	Qrr	di/dt = –100 A/μs		72		nC

Note Pulsed test PW \leq 350 μ s, Duty Cycle \leq 2%

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = -20 \rightarrow 0 \text{ V}$ V_{DD} V_{DD}

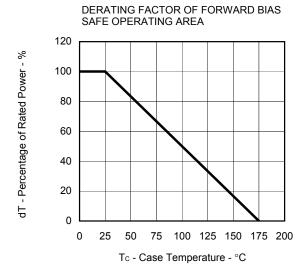
TEST CIRCUIT 2 SWITCHING TIME

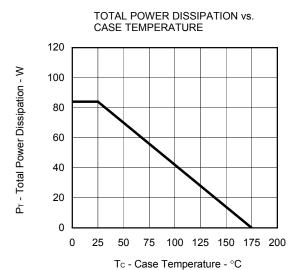


TEST CIRCUIT 3 GATE CHARGE

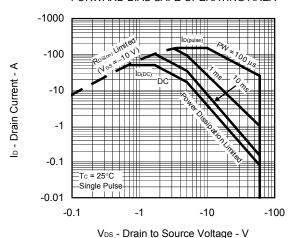
$$\begin{array}{c|c} D.U.T. & \\ \hline \\ I_G = -2 \text{ mA} \\ \hline \\ PG. & \\ \hline \\ \end{array} \begin{array}{c} R_L \\ \hline \\ V_{DD} \\ \hline \end{array}$$

TYPICAL CHARACTERISTICS (TA = 25°C)

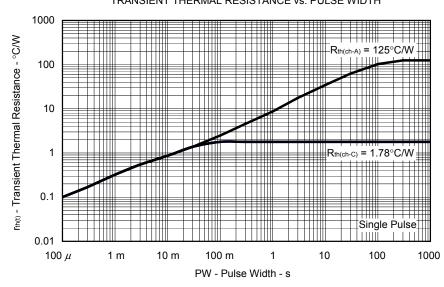




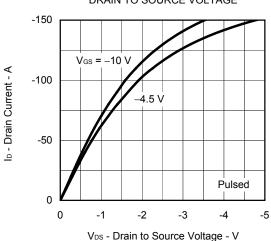
FORWARD BIAS SAFE OPERATING AREA



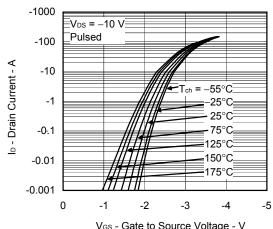
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH





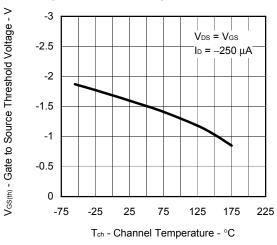


FORWARD TRANSFER CHARACTERISTICS

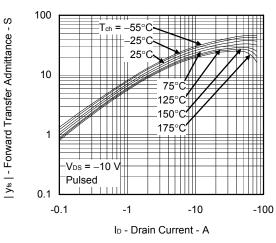


V_{GS} - Gate to Source Voltage - V

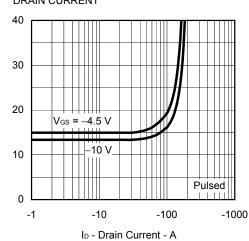
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



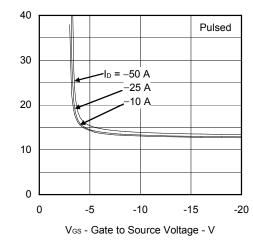
FORWARD TRANSFER ADMITTANCE vs. **DRAIN CURRENT**



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



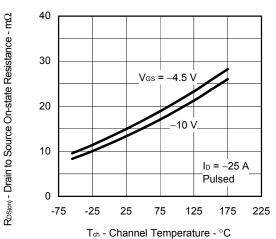
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



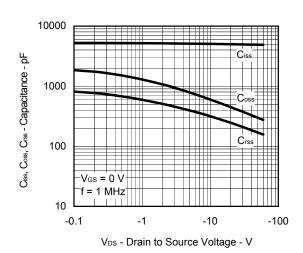
R_{DS(on)} - Drain to Source On-state Resistance - mΩ

RDS(on) - Drain to Source On-state Resistance - mΩ

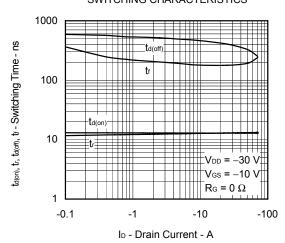




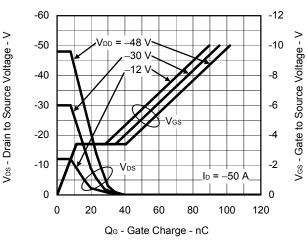
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



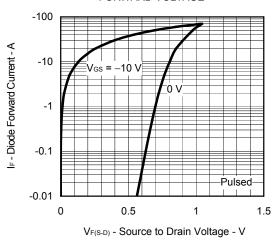
SWITCHING CHARACTERISTICS



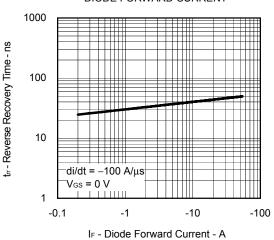
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



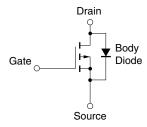
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



PACKAGE DRAWING (Unit: mm)

TO-252 (MP-3ZK) 1.0 TYP. 0.5±0.1 5.1 TYP. 4.3 MIN. No Plating (9.8 TYP. 6.1 ± 0.2 0.51 MIN No Plating 0.76±0.12 1.14 MAX 0 to 0.25 0.5±0.1 1. Gate 2. Drain 3. Source 4. Fin (Drain)

EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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